EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	19	("2250556" "2931760" "3915809" " 4350564" "5294326" "5425822"). PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/05 16:09
S2	1322	(substrate material) and ((metal adj (film layer)) cr chromium titanium ti tungsten w wolfram palladium pd molybdenum mo) and (((second adj (metal adj (film layer))) al aluminum copper cu gold au silver ag) with (pattern pattern\$\$3)) and ((positive adj electrode) (anode adj (plate mesh)) anode) and (((acid acid\$\$3) adj (electrolyte solution)) ((hydrochloric sulfuric carboxylic hydrofluoric phosphoric orthophosphoric) adj acid) HCl H2SO4 H2CO3 CH3COOH C2O2H4 HF H3PO4) and ((reduction reduc\$\$3 remov\$\$3) with ((passivation passivat\$\$3 oxidiz\$\$3 oxidation oxide) near3 (layer film cr chromium titanium ti tungsten w wolfram palladium pd molybdenum mo))) and (etch etch\$\$3 polish polish\$\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2007/02/05 13:04
S3	697	(substrate material) and ((etch etch\$3 polish polish\$3) with ((metal adj (film layer)) cr chromium titanium ti tungsten w wolfram palladium pd molybdenum mo)) and (((second adj (metal adj (film layer))) al aluminum copper cu gold au silver ag) with (pattern pattern\$3)) and ((positive adj electrode) (anode adj (plate mesh)) anode) and (((acid acid\$3) adj (electrolyte solution)) ((hydrochloric sulfuric carboxylic hydrofluoric phosphoric orthophosphoric) adj acid) HCI H2SO4 H2CO3 CH3COOH C2O2H4 HF H3PO4) and ((reduction reduc\$3 remov\$3) with ((passivation passivat\$3 oxidiz\$3 oxidation oxide) near3 (layer film cr chromium titanium ti tungsten w wolfram palladium pd molybdenum mo)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/05 13:25

EAST Search History

S4	76	(substrate material) and ((etch etch\$3 polish polish\$3) with ((metal adj (film layer)) cr chromium titanium ti tungsten w wolfram palladium pd molybdenum mo)) and (((second adj (metal adj (film layer))) al aluminum copper cu gold au silver ag) with (pattern pattern\$3)) and (((acid acid\$3) adj (electrolyte solution)) ((hydrochloric sulfuric carboxylic hydrofluoric phosphoric orthophosphoric) adj acid) HCI H2SO4 H2CO3 CH3COOH C2O2H4 HF H3PO4) and (((positive adj electrode) (anode adj (plate mesh)) anode) same ((reduction reduc\$3 remov\$3) with ((passivation passivat\$3 oxidiz\$3 oxidation oxide) near3 (layer film cr chromium titanium ti tungsten w wolfram palladium pd molybdenum	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON ·	2007/02/05 13:27
		mo))))				